

IAP20 Rec'd PCT/PTO 29 MAR 2006

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: METHOD FOR PREPARING CONDUCTIVE
PASTE FOR INNER ELECTRODE OF MULTI-
LAYERED CERAMIC ELECTRONIC
COMPONENT

Attorney Docket Number:: 890050.538USPC

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?:: No

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type:: Inventor
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Status:: Full Capacity
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Middle Name::
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Correspondence InformationCorrespondence Customer Number :: **00500****Representative Information**

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/014161	09/28/04

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-340400	09/30/03	Yes

Assignee Information

Assignee name::	TDK Corporation
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